

Complete 12-Bit 30 MSPS CCD Signal Processor

AD9845B

FEATURES

Pin Compatible with AD9845A Designs
12-Bit 30 MSPS A/D Converter
30 MSPS Correlated Double Sampler (CDS)
4 dB ± 6 dB 6-Bit Pixel Gain Amplifier (PxGA®)
2 dB to 36 dB 10-Bit Variable Gain Amplifier (VGA)
Low Noise Clamp Circuits
Preblanking Function
Auxiliary Inputs with VGA and Input Clamp
3-Wire Serial Digital Interface
3 V Single-Supply Operation
Low Power: 153 mW @ 3 V Supply
Space-Saving 48-Lead LQFP Package

APPLICATIONS

High Performance Digital Still Cameras Industrial/Scientific Imaging

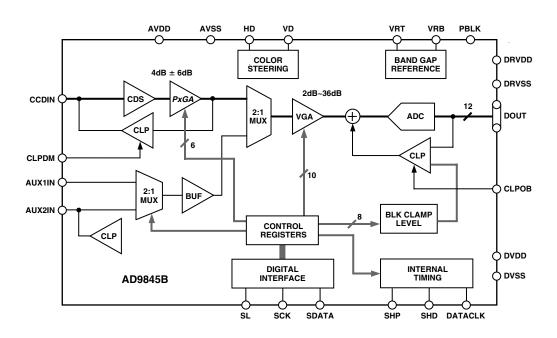
GENERAL DESCRIPTION

The AD9845B is an improved version of the AD9845A CCD signal processor. It features a 30 MHz single-channel architecture designed to sample and condition the outputs of interlaced and progressive scan area CCD arrays. The AD9845B's signal chain consists of an input clamp, a correlated double sampler (CDS), PxGA, a digitally controlled VGA, a black level clamp, and a 12-bit A/D converter. Additional input modes are also provided for processing analog video signals.

The internal registers are programmed through a 3-wire serial digital interface. Programmable features include gain adjustment, black level adjustment, input configuration, and power-down modes.

The AD9845B operates from a single 3 V power supply, typically dissipates 153 mW, and is packaged in a 48-lead LQFP.

FUNCTIONAL BLOCK DIAGRAM



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AD9845B-SPECIFICATIONS

GENERAL SPECIFICATIONS (T_{MIN} to T_{MAX} , AVDD = DVDD = 3.0 V, $f_{DATACLK}$ = 30 MHz, unless otherwise noted.)

Parameter	Min	Тур	Max	Unit
TEMPERATURE RANGE Operating	-20		+85	°C
Storage	-65		+150	°C
POWER SUPPLY VOLTAGE Analog, Digital, Digital Driver	2.7		3.6	V
POWER CONSUMPTION Normal Operation Power-Down Modes Standby	(Specified	d under Each Mo	ode of Operation)	mW
Total Power-Down		0.5		mW
MAXIMUM CLOCK RATE	30			MHz
A/D CONVERTER Resolution Differential Nonlinearity (DNL) No Missing Codes Full-Scale Input Voltage Data Output Coding	12 12	±0.5 2.0 Straight Binary	±1.0	Bits LSB Bits Guaranteed V
VOLTAGE REFERENCE Reference Top Voltage (VRT) Reference Bottom Voltage (VRB)		2.0 1.0		V V

Specifications subject to change without notice.

DIGITAL SPECIFICATIONS (DRVDD = 2.7 V, $C_L = 20 \text{ pF}$, unless otherwise noted.)

Parameter	Symbol	Min	Тур	Max	Unit
LOGIC INPUTS					
High Level Input Voltage	V_{IH}	2.1			V
Low Level Input Voltage	$V_{ m IL}$			0.6	V
High Level Input Current	I_{IH}		10		μΑ
Low Level Input Current	$I_{\rm IL}$		10		μA
Input Capacitance	C_{IN}		10		pF
LOGIC OUTPUTS					
High Level Output Voltage, $I_{OH} = 2 \text{ mA}$	V _{OH}	2.2			V
Low Level Output Voltage, I _{OL} = 2 mA	V _{OL}			0.5	V

Specifications subject to change without notice.

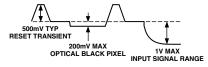
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$\begin{array}{c} \textbf{CCD MODE SPECIFICATIONS} \text{ (T_{MIN} to T_{MAX}, AVDD} = DVDD = 3.0 \text{ V}, \\ f_{DATACLK} = f_{SHP} = f_{SHD} = 30 \text{ MHz, unless otherwise noted.)} \end{array}$

Parameter	Min Typ Max	Unit	Notes
POWER CONSUMPTION	153	mW	See TPC 1 for Power Curves
MAXIMUM CLOCK RATE	30	MHz	
CDS Gain Allowable CCD Reset Transient ¹ Max Input Range before Saturation ¹ Max CCD Black Pixel Amplitude ¹	0 500 1.0 200	dB mV V p-p mV	PxGA Gain at 4 dB
PIXEL GAIN AMPLIFIER (PxGA) Max Input Range Max Output Range Gain Control Resolution Gain Monotonicity Gain Range (Twos Complement Coding) Min Gain (PxGA Gain Code 32) Max Gain (PxGA Gain Code 31)	1.0 1.6 64 Guaranteed -2.5 9.5	V p-p V p-p Steps dB dB	See Figure 28 for <i>PxGA</i> Gain Curve
VARIABLE GAIN AMPLIFIER (VGA) Max Input Range Max Output Range Gain Control Resolution Gain Monotonicity Gain Range Low Gain (VGA Gain Code 77) Max Gain (VGA Gain Code 1023)	1.6 2.0 1024 Guaranteed 2 36	V p-p V p-p Steps dB dB	See Figure 29 for VGA Gain Curve
BLACK LEVEL CLAMP Clamp Level Resolution Clamp Level Min Clamp Level Max Clamp Level	256 0 255	Steps LSB LSB	Measured at ADC Output
SYSTEM PERFORMANCE Gain Accuracy ² Low Gain (VGA Code 77) Max Gain (VGA Code 1023) Peak Nonlinearity, 500 mV Input Signal Total Output Noise Power Supply Rejection (PSR)	5.5 6 6.5 38.2 39.5 40.2 0.1 0.5 40	dB dB % LSB rms dB	Specifications Include Entire Signal Chain Gain = (0.0353 × Code) + 3.3 12 dB Gain Applied AC Grounded Input, 6 dB Gain Applied Measured with Step Change on Supply
POWER-UP RECOVERY TIME Reference Standby Mode Total Shutdown Mode Power-Off Condition	1 3 15	ms ms ms	Normal Clock Signals Applied

NOTES

¹Input signal characteristics defined as follows:



 2PxGA gain fixed at Code 63 (3.3 dB).

Specifications subject to change without notice.

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AUX1 MODE SPECIFICATIONS (T_{MIN} to T_{MAX} , AVDD = DVDD = 3.0 V, $f_{DATACLK}$ = 30 MHz, unless otherwise noted.)

Parameter	Min	Typ	Max	Unit
POWER CONSUMPTION		120		mW
MAXIMUM CLOCK RATE	30			MHz
INPUT BUFFER Gain Max Input Range	1.0	0		dB V p-p
VGA Max Output Range Gain Control Resolution Gain (Selected Using VGA Gain Register)	2.0	1023		V p-p Steps
Min Gain Max Gain		0 36		dB dB

Specifications subject to change without notice.

$\textbf{AUX2 MODE SPECIFICATIONS} \ \, (\textbf{T}_{\text{MIN}} \ \, \textbf{to} \ \, \textbf{T}_{\text{MAX}}, \ \, \textbf{AVDD} = \textbf{DVDD} = 3.0 \ \, \textbf{V}, \ \, \textbf{f}_{\text{DATACLK}} = 30 \ \, \text{MHz}, \ \, \textbf{unless otherwise noted.})$

Parameter	Min	Тур	Max	Unit
POWER CONSUMPTION		120		mW
MAXIMUM CLOCK RATE	30			MHz
INPUT BUFFER	(Same	e as AUX1 MODE)		
VGA Max Output Range Gain Control Resolution Gain (Selected Using VGA Gain Register) Min Gain Max Gain	2.0	512 0 +18		V p-p Steps dB dB
ACTIVE CLAMP Clamp Level Resolution Clamp Level (Measured at ADC Output) Min Clamp Level Max Clamp Level		256 0 255		Steps LSB LSB

Specifications subject to change without notice.

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TIMING SPECIFICATIONS ($C_L = 20$ pF, $f_{SAMP} = 30$ MHz, CCD Mode Timing in Figures 5 and 6, AUX Mode Timing in Figure 7, Serial Timing in Figures 21–24.)

Parameter	Symbol	Min	Typ	Max	Unit
SAMPLE CLOCKS					
DATACLK, SHP, SHD Clock Period	t _{CP}	33	33		ns
DATACLK High/Low Pulsewidth	t_{ADC}	13	16.7		ns
SHP Pulsewidth	t _{SHP}	5	8.3		ns
SHD Pulsewidth	t _{SHD}	5	8.3		ns
CLPDM Pulsewidth	t_{CDM}	4	10		Pixels
CLPOB Pulsewidth*	t_{COB}	2	20		Pixels
SHP Rising Edge to SHD Falling Edge	t _{S1}	0	8.3		ns
SHP Rising Edge to SHD Rising Edge	t_{S2}	15	16.7		ns
Internal Clock Delay	t_{ID}		3.0		ns
Inhibited Clock Period	t _{INH}	10			ns
DATA OUTPUTS					
Output Delay	t _{OD}		13	16	ns
Output Hold Time	t _H	7.0	7.6		ns
Pipeline Delay			9		Cycles
SERIAL INTERFACE					
Maximum SCK Frequency	f_{SCLK}	10			MHz
SL to SCK Setup Time	t _{LS}	10			ns
SCK to SL Hold Time	t _{LH}	10			ns
SDATA Valid to SCK Rising Edge Setup	t _{DS}	10			ns
SCK Falling Edge to SDATA Valid Hold	t _{DH}	10			ns
SCK Falling Edge to SDATA Valid Read	t _{DV}	10			ns

^{*}Minimum CLPOB pulsewidth is for functional operation only. Wider typical pulses are recommended to achieve low noise clamp performance. Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS

Parameter	With Respect To	Min	Max	Unit
AVDD1, AVDD2	AVSS	-0.3	+3.9	V
DVDD1, DVDD2	DVSS	-0.3	+3.9	V
DRVDD	DRVSS	-0.3	+3.9	V
Digital Outputs	DRVSS	-0.3	DRVDD + 0.3	V
SHP, SHD, DATACLK	DVSS	-0.3	DVDD + 0.3	V
CLPOB, CLPDM, PBLK	DVSS	-0.3	DVDD + 0.3	V
SCK, SL, SDATA	DVSS	-0.3	DVDD + 0.3	V
VRT, VRB	AVSS	-0.3	AVDD + 0.3	V
BYP1-3, CCDIN	AVSS	-0.3	AVDD + 0.3	V
Junction Temperature			150	°C
Lead Temperature (10 sec)			300	°C

ORDERING GUIDE

Model	Temperature	Package	Package
	Range	Description	Option
AD9845BJST	−20°C to +85°C	LQFP	ST-48

THERMAL CHARACTERISTICS

Thermal Resistance 48-Lead LQFP Package $\theta_{JA} = 56^{\circ}\text{C/W}^*$

 $^*\theta_{JA}\,\text{is}$ measured using a 4-layer PCB.

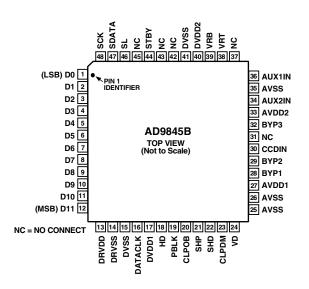
CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD9845B features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



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PIN CONFIGURATION



PIN FUNCTION DESCRIPTIONS

Pin Number	Name	Type	Description
1–12	D0-D11	DO	Digital Data Outputs. Pin 12 (D11) is MSB.
13	DRVDD	P	Digital Output Driver Supply
14	DRVSS	P	Digital Output Driver Ground
15, 41	DVSS	P	Digital Ground
16	DATACLK	DI	Digital Data Output Latch Clock
17	DVDD1	P	Digital Supply 1
18	HD	DI	Horizontal Drive. Used with VD for color steering control.
19	PBLK	DI	Preblanking Clock Input
20	CLPOB	DI	Black Level Clamp Clock Input
21	SHP	DI	CDS Sampling Clock for CCD's Reference Level
22	SHD	DI	CDS Sampling Clock for CCD's Data Level
23	CLPDM	DI	Input Clamp Clock Input
24	VD	DI	Vertical Drive. Used with HD for color steering control.
25, 26, 35	AVSS	P	Analog Ground
27	AVDD1	P	Analog Supply 1
28	BYP1	AO	Internal Bias Level Decoupling
29	BYP2	AO	Internal Bias Level Decoupling
30	CCDIN	AI	Analog Input for CCD Signal
31	NC	NC	Internally Not Connected
32	BYP3	AO	Internal Bias Level Decoupling
33	AVDD2	P	Analog Supply 2
34	AUX2IN	AI	Analog Input
36	AUX1IN	AI	Analog Input
37	NC	NC	Internally Not Connected
38	VRT	AO	A/D Converter Top Reference Voltage Decoupling
39	VRB	AO	A/D Converter Bottom Reference Voltage Decoupling
40	DVDD2	P	Digital Supply 2
42	NC	NC	Internally Not Connected
43	NC	NC	Internally Not Connected
44	STBY	DI	Standby Mode, Active High. Same as total power-down mode.
45	NC	NC	Internally Not Connected
46	SL	DI	Serial Digital Interface Load Pulse
47	SDATA	DI	Serial Digital Interface Data
48	SCK	DI	Serial Digital Interface Clock

 $TYPE: AI = Analog \ Input, AO = Analog \ Output, DI = Digital \ Input, DO = Digital \ Output, P = Power$

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DEFINITIONS OF SPECIFICATIONS

Differential Nonlinearity (DNL)

An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value. Thus, every code must have a finite width. No missing codes guaranteed to 12-bit resolution indicates that all 4096 codes, must be present over all operating conditions.

Peak Nonlinearity

Peak nonlinearity, a full signal chain specification, refers to the peak deviation of the output of the AD9845B from a true straight line. The point used as "zero scale" occurs 1/2 LSB before the first code transition. "Positive full scale" is defined as a Level 1, 1/2 LSB beyond the last code transition. The deviation is measured from the middle of each particular output code to the true straight line. The error is then expressed as a percentage of the 2 V ADC full-scale signal. The input signal is always appropriately gained up to fill the ADC's full-scale range.

Total Output Noise

The rms output noise is measured using histogram techniques. The standard deviation of the ADC output codes is calculated in LSB and represents the rms noise level of the total signal chain at the specified gain setting. The output noise can be converted to an equivalent voltage using the relationship

where N is the bit resolution of the ADC. For the AD9845B, 1 LSB is approximately 488 μ V.

Power Supply Rejection (PSR)

The PSR is measured with a step change applied to the supply pins. This represents a high frequency disturbance on the AD9845B's power supply. The PSR specification is calculated from the change in the data outputs for a given step change in the supply voltage.

Internal Delay for SHP/SHD

The internal delay (also called aperture delay) is the time delay that occurs from when a sampling edge is applied to the AD9845B until the actual sample of the input signal is held. Both SHP and SHD sample the input signal during the transition from low to high, so the internal delay is measured from each clock's rising edge to the instant the actual internal sample is taken.

EQUIVALENT INPUT CIRCUITS

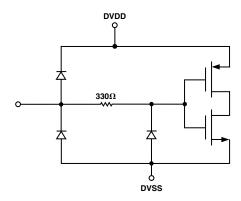


Figure 1. Digital Inputs—SHP, SHD, DATACLK, CLPOB, CLPDM, HD, VD, PBLK, SCK, and SL

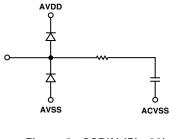


Figure 3. CCDIN (Pin 30)

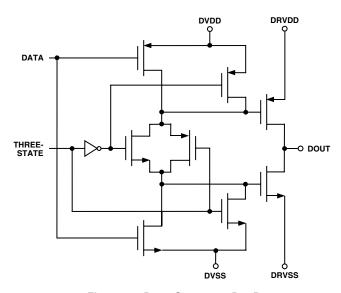


Figure 2. Data Outputs – D0–D11

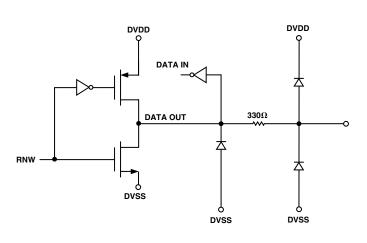
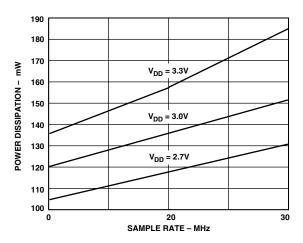
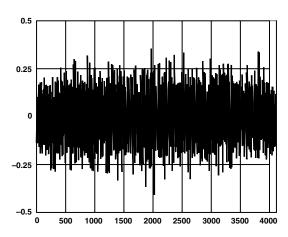


Figure 4. SDATA (Pin 45)

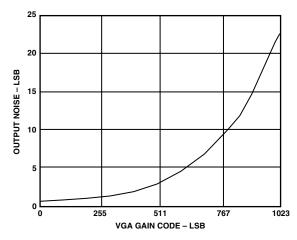
AD9845B—Typical Performance Characteristics



TPC 1. Power vs. Sample Rate



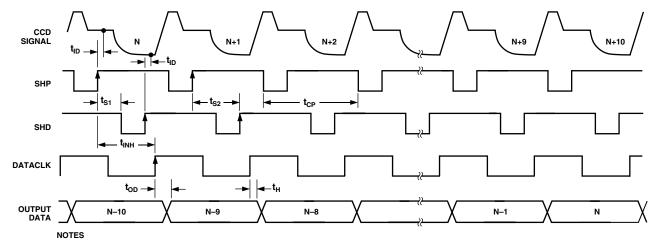
TPC 2. Typical DNL Performance



TPC 3. Output Noise vs. VGA Gain

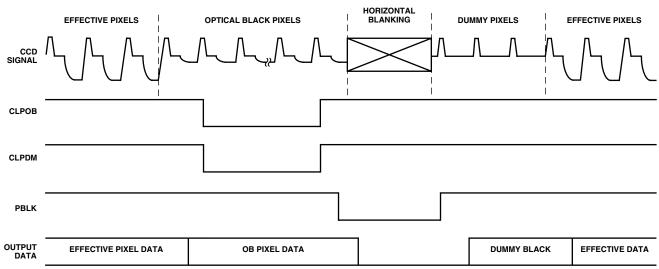
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CCD MODE AND AUX MODE TIMING



NOTES
1. RECOMMENDED PLACEMENT FOR DATACLK RISING EDGE IS BETWEEN THE SHD RISING EDGE AND NEXT SHP FALLING EDGE.
2. CCD SIGNAL IS SAMPLED AT SHP AND SHD RISING EDGES.

Figure 5. CCD Mode Timing



NOTES

- 1. CLPOB AND CLPDM WILL OVERWRITE PBLK. PBLK WILL NOT AFFECT CLAMP OPERATION IF OVERLAPPING CLPDM AND/OR CLPOB.
 2. PBLK SIGNAL IS OPTIONAL.
 3. DIGITAL OUTPUT DATA WILL BE ALL ZEROS DURING PBLK. OUTPUT DATA LATENCY IS NINE DATACLK CYCLES.

Figure 6. Typical CCD Mode Line Clamp Timing

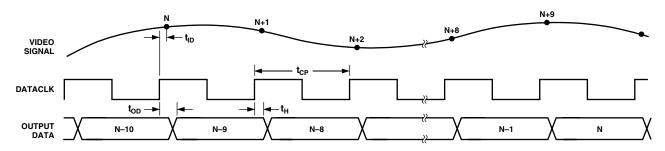


Figure 7. AUX Mode Timing

PIXEL GAIN AMPLIFIER (PxGA) TIMING

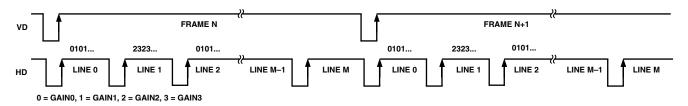
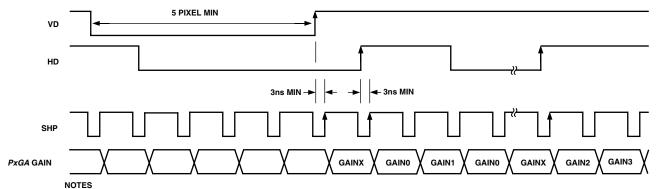


Figure 8. PxGA Mode 1 (Mosaic Separate) Frame/Line Gain Register Sequence



- 1. MINIMUM PULSEWIDTH FOR HD AND VD IS FIVE PIXEL CYCLES.
 2. BOTH VD AND HD ARE INTERNALLY UPDATED AT SHP RISING EDGES. MINIMUM SETUP TIME IS 3 ns.
 3. EVERY HD RISING EDGE WITH A PREVIOUS VD RISING EDGE WILL RESET TO 0101.
 4. EVERY HD RISING EDGE WITHOUT A PREVIOUS VD RISING EDGE WILL ALTERNATE BETWEEN 0101... AND 2323.

Figure 9. PxGA Mode 1 (Mosaic Separate) Detailed Timing

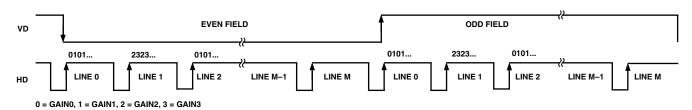
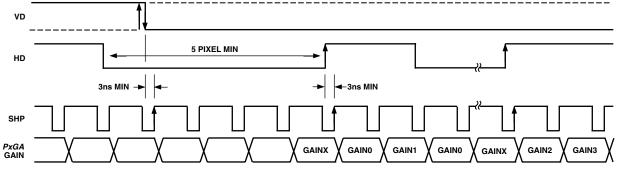


Figure 10. PxGA Mode 2 (Interlace) Frame/Line Gain Register Sequence



- NOTES
- 1. BOTH VD AND HD ARE INTERNALLY UPDATED AT SHP RISING EDGES.
 2. EVERY HD RISING EDGE WITH A PREVIOUS VD RISING OR FALLING EDGE WILL RESET TO 0101.
 3. EVERY HD RISING EDGE WITHOUT A PREVIOUS VD RISING EDGE WILL ALTERNATE BETWEEN 0101... AND 2323.

Figure 11. PxGA Mode 2 (Interlace) Detailed Timing

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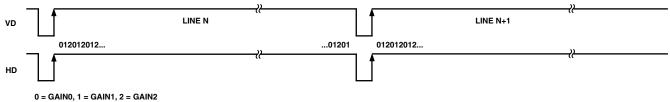
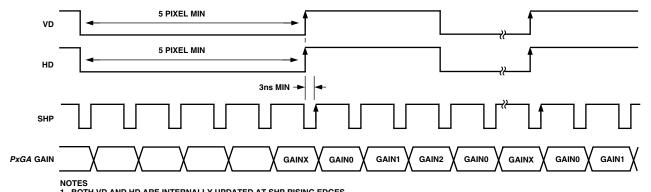


Figure 12. PxGA Mode 3 (3-Color) Frame/Line Gain Register Sequence



- 1. BOTH VD AND HD ARE INTERNALLY UPDATED AT SHP RISING EDGES.
 2. EVERY HD RISING EDGE WITH A PREVIOUS VD RISING EDGE WILL RESET TO 012012.
 - Figure 13. PxGA Mode 3 (3-Color) Detailed Timing

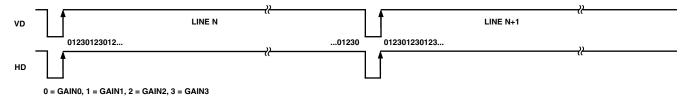
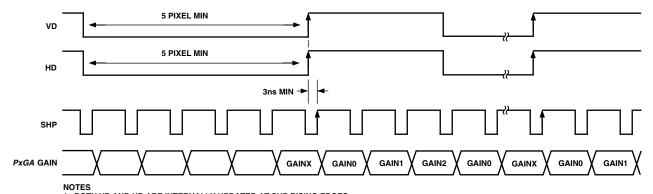


Figure 14. PxGA Mode 4 (4-Color) Frame/Line Gain Register Sequence



1. BOTH VD AND HD ARE INTERNALLY UPDATED AT SHP RISING EDGES.
2. EVERY HD RISING EDGE WITH A PREVIOUS VD RISING EDGE WILL RESET TO 01230123.

Figure 15. PxGA Mode 4 (4-Color) Detailed Timing

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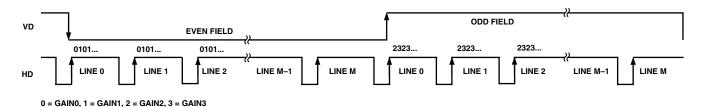


Figure 16. PxGA Mode 5 (VD Selected) Frame/Line Gain Register Sequence

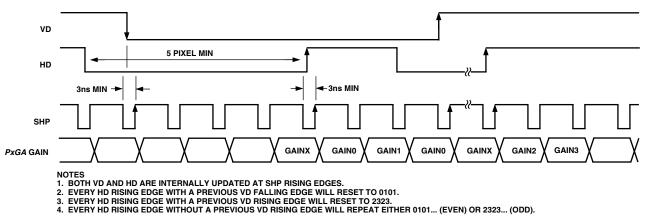


Figure 17. PxGA Mode 5 (VD Selected) Detailed Timing

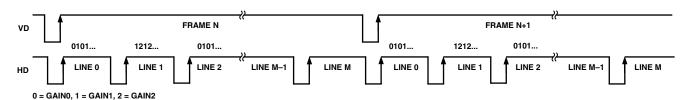
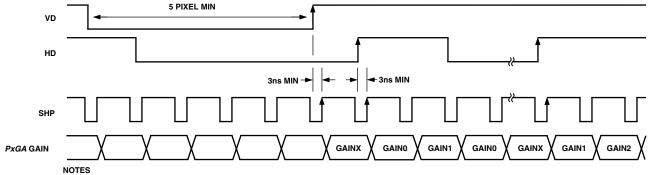
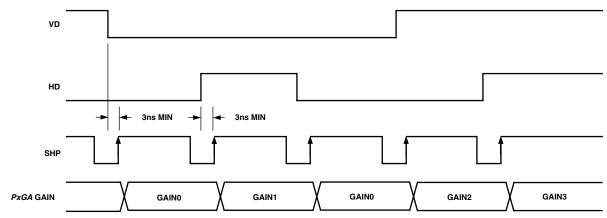


Figure 18. PxGA Mode 6 (Mosaic Repeat) Frame/Line Gain Register Sequence



- 1. MINIMUM PULSEWIDTH FOR HD AND VD IS 5 PIXEL CYCLES.
 2. BOTH VD AND HD ARE INTERNALLY UPDATED AT SHP RISING EDGES. MINIMUM SETUP TIME IS 3 ns.
 3. EVERY HD RISING EDGE WITH A PREVIOUS VD RISING EDGE WILL RESET TO 0101.
 4. EVERY HD RISING EDGE WITHOUT A PREVIOUS VD RISING EDGE WILL ALTERNATE BETWEEN 0101... AND 1212.

Figure 19. PxGA Mode 6 (Mosaic Repeat) Detailed Timing



- NOTES

 1. BOTH VD AND HD ARE INTERNALLY UPDATED AT SHP RISING EDGES.

 2. VD = 0 AND HD = 0 SELECTS GAINO.

 3. VD = 0 AND HD = 1 SELECTS GAIN1.

 4. VD = 1 AND HD = 0 SELECTS GAIN2.

 5. VD = 1 AND HD = 1 SELECTS GAIN3.

Figure 20. PxGA Mode 7 (User Specified) Detailed Timing

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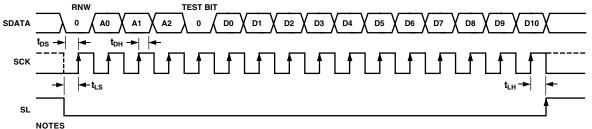
SERIAL INTERFACE TIMING AND INTERNAL REGISTER DESCRIPTION

Table I. Internal Register Map

Register	Ac	ldre	ess						Data Bits					
Name	A0	A1	A2	D0	D1	D 2	D 3	D 4	D 5	D 6	$\mathbf{D}7$	$\mathbf{D8}$	D 9	D 10
Operation	0	0	0		nel Select AUX1/2	Power- Modes		Software Reset	OB Clamp On/Off	01	12	01	01	01
VGA Gain	1	0	0	LSB									MSB	X
Clamp Level	0	1	0	LSB							MSB	X	X	X
Control	1	1	0	Color Select	Steering I	Mode	PxGA On/Off		arity Select for D/CLP/DATA		01	01	Three- State	X
PxGA Gain0	0	0	1	LSB					MSB	X	X	X	X	X
PxGA Gain1	1	0	1	LSB					MSB	X	X	X	X	X
PxGA Gain2	0	1	1	LSB					MSB	X	X	X	X	X
PxGA Gain3	1	1	1	LSB					MSB	X	X	X	X	X

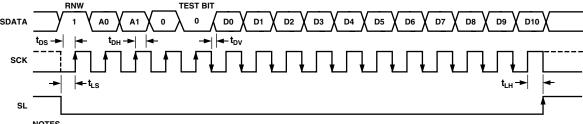
NOTES

²Must be set to 1.



- 1. SDATA BITS ARE INTERNALLY LATCHED ON THE RISING EDGES OF SCK.
 2. RNW = READ-NOT-WRITE. SET LOW FOR WRITE OPERATION.
 3. TEST BITS = INTERNAL USE ONLY. MUST BE SET LOW.
 4. SYSTEM UPDATE OF LOADED REGISTERS OCCURS ON SL RISING EDGE.

Figure 21. Serial Write Operation

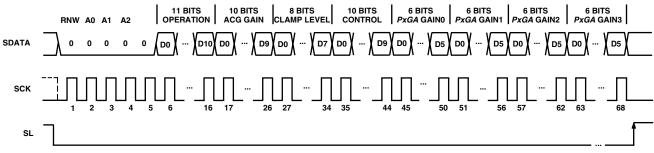


- NOTES
- 1. RNW = READ-NOT-WRITE. SET HIGH FOR READ OPERATION.
 2. TEST BITS = INTERNAL USE ONLY. MUST BE SET LOW.
 3. SERIAL DATA FROM THE SELECTED REGISTER IS VALID STARTING AFTER THE FIFTH SCK FALLING EDGE AND IS UPDATED ON SCK FALLING EDGES.

Figure 22. Serial Readback Operation

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¹Internal use only. Must be set to 0.



NOTES

Figure 23. Continuous Serial Write Operation to All Registers

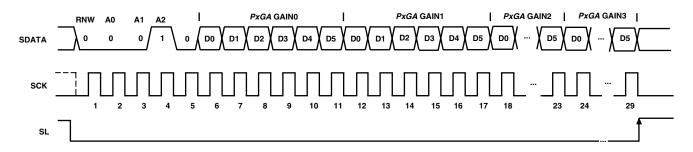


Figure 24. Continuous Serial Write Operation to All PxGA Gain Registers

Table II. Operation Register Contents (Default Value x000)

D 10	D9	D 8	D 7	D6	Optical Black Clamp D5	Reset D4	Pow D3		Down Modes	_	ann D(el Selection
01	01	01	12	0^1	0 Enable Clamping 1 Disable Clamping	0 Normal 1 Reset All Registers to Default	0 0 1 1	1 0	Normal Power Test Only Standby Total Power-Down	0 0 1 1	0 1 0 1	CCD Mode AUX1 Mode AUX2 Mode Test Only

NOTES

Table III. VGA Gain Register Contents (Default Value x000)

D 10	MSB D9	D8	D 7	D6	D 5	D 4	D 3	D2	D1	LSB D0	Gain (dB)
X	0	0	0	1	0	1	1	1	1	1	2.0
					•						•
					•						•
					•						•
	1	1	1	1	1	1	1	1	1	0	35.965
	1	1	1	1	1	1	1	1	1	1	36.0

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^{1.} ANY NUMBER OF ADJACENT REGISTERS MAY BE LOADED SEQUENTIALLY, BEGINNING WITH THE LOWEST ADDRESS AND INCREMENTING ONE ADDRESS AT A TIME.
2. WHEN SEQUENTIALLY LOADING MULTIPLE REGISTERS, THE EXACT REGISTER LENGTH (SHOWN ABOVE) MUST BE USED FOR EACH REGISTER.
3. ALL LOADED REGISTERS WILL BE SIMULTANEOUSLY UPDATED WITH THE RISING EDGE OF SL.

¹Must be set to 0.

²Set to 1.

Table IV. Clamp Level Register Contents (Default Value x080)

			MSB							LSB	
D 10	D 9	D 8	D 7	D 6	D 5	D 4	D 3	D 2	D 1	$\mathbf{D0}$	Clamp Level (LSB)
X	X	X	0	0	0	0	0	0	0	0	0
			0	0	0	0	0	0	0	1	1
			0	0	0	0	0	0	1	0	2
						•					•
						•					•
						•					•
			1	1	1	1	1	1	1	0	254
			1	1	1	1	1	1	1	1	255

Table V. Control Register Contents (Default Value x000)

D10	Data Out D9	D8	D 7	DATACLK D6	CLP/PBLK D5	SHP/SHD D4	PxGA D3 ²		or Si D1	teering Modes D0
X	0 Enable 1 Three-State	01	01	0 Rising Edge Trigger 1 Falling Edge Trigger			0 Disable 1 Enable		0	0 Steering Disabled 1 Mosaic Separate
	1 Three-State			1 Failing Edge Trigger	Active right	Active High	1 Ellable	0	1	0 Interlace
								0	1	1 3-Color 0 4-Color
								1	0	1 VD Selected
								1 1	1 1	0 Mosaic Repeat1 User Specified

NOTES

Table VI. PxGA Gain Registers for Gain0, Gain1, Gain2, Gain3 (Default Value x000)

D 10	D 9	D 8	D 7	D 6	MSB D5	D 4	D 3	D2	D 1	LSB D0	Gain (dB)*
$\overline{\mathbf{x}}$	X	X	X	X	0	1	1	1	1	1	+9.5
							•				•
							•				•
							•				•
					0	0	0	0	0	0	+3.5
					1	1	1	1	1	1	+3.3
							•				•
							•				•
							•				•
					1	0	0	0	0	0	-2.5

^{*}Control Register Bit D3 must be set high (PxGA Enable) to use the PxGA Gain Registers.

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¹ Must be set to 0.

 $^{^2}$ When D3 = 0 (PxGA disabled), the PxGA gain is fixed to Code 63 (3.3 dB).

CIRCUIT DESCRIPTION AND OPERATION

The AD9845B signal processing chain is shown in Figure 25. Each processing step is essential in achieving a high quality image from the raw CCD pixel data.

DC Restore

To reduce the large dc offset of the CCD output signal, a dc restore circuit is used with an external 0.1 μ F series coupling capacitor. This restores the dc level of the CCD signal to approximately 1.5 V to be compatible with the 3 V single supply of the AD9845B.

Correlated Double Sampler

The CDS circuit samples each CCD pixel twice to extract the video information and reject low frequency noise. The timing shown in Figure 5 illustrates how the two CDS clocks, SHP and SHD, are used to sample the reference level and data level of the CCD signal, respectively. The CCD signal is sampled on the rising edges of SHP and SHD. Placement of these two clock signals is critical to achieving the best performance from the CCD. An internal SHP/SHD delay ($t_{\rm ID}$) of 3 ns is caused by internal propagation delays.

Input Clamp

A line-rate input clamping circuit is used to remove the CCD's optical black offset. This offset exists in the CCD's shielded black reference pixels. Unlike some AFE architectures, the AD9845B removes this offset in the input stage to minimize the effect of a

gain change on the system black level. Another advantage of removing this offset at the input stage is to maximize system headroom. Some area CCDs have large black level offset voltages, which, if not corrected at the input stage, can significantly reduce the available headroom in the internal circuitry when higher VGA gain settings are used.

Horizontal timing is shown in Figure 6. It is recommended that the CLPDM pulse be used during valid CCD dark pixels. CLPDM may be used during the optical black pixels, either together with CLPOB or separately. The CLPDM pulse should be a minimum of 4 pixels wide.

$P_{\gamma}GA$

The *PxGA* provides separate gain adjustment for the individual color pixels. A programmable gain amplifier with four separate values, the *PxGA* has the capability to multiplex its gain value on a pixel-to-pixel basis. This allows lower output color pixels to be gained up to match higher output color pixels. Also, the *PxGA* may be used to adjust the colors for white balance, reducing the amount of digital processing that is needed. The four different gain values are switched according to the color steering circuitry. Seven different color steering modes for different types of CCD color filter arrays are programmed in the AD9845B's Control Register. For example, mosaic separate steering mode accommodates the popular "Bayer" arrangement of red, green, and blue filters (see Figure 26).

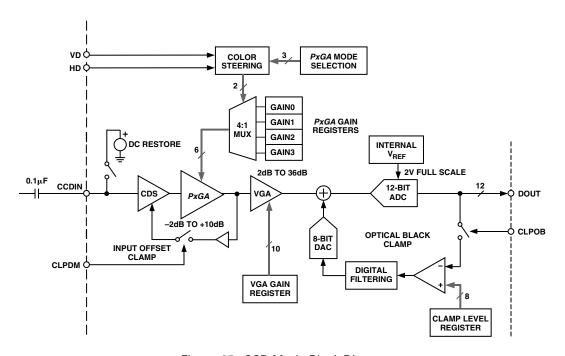


Figure 25. CCD Mode Block Diagram

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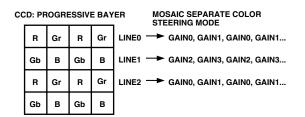


Figure 26. CCD Color Filter Example: Progressive Scan

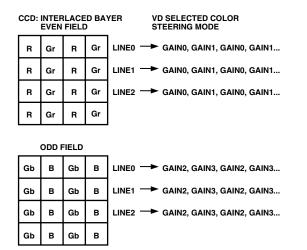


Figure 27. CCD Color Filter Example: Interlaced

The same Bayer pattern can also be interlaced, and the VD selected mode should be used with this type of CCD (see Figure 27). The color steering performs the proper multiplexing of the R, G, and B gain values (loaded into the PxGA gain registers) and is synchronized by the user with vertical (VD) and horizontal (HD) sync pulses. For more detailed information, see the PxGA Timing section. The PxGA gain for each of the four channels is variable from -2.5 dB to +9.5 dB, controlled in 64 steps through the serial interface. The PxGA gain curve is shown in Figure 28.

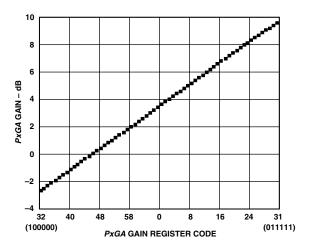


Figure 28. PxGA Gain Curve

Variable Gain Amplifier

The VGA stage provides a gain range of 2 dB to 36 dB, programmable with 10-bit resolution through the serial digital interface. Combined with approximately 4 dB from the *PxGA* stage, the total gain range for the AD9845B is 6 dB to 40 dB. The minimum gain of 6 dB is needed to match a 1 V input signal with the ADC full-scale range of 2 V. When compared to 1 V full-scale systems (such as ADI's AD9803), the equivalent gain range is 0 dB to 34 dB.

The VGA gain curve follows a "linear-in-dB" shape. The exact VGA gain can be calculated for any gain register value by using the following equation:

Code Range Gain Equation (dB) 0-1023 Gain = (0.0353)(Code)

As shown in the CCD Mode Specifications, only the VGA gain range from 2 dB to 36 dB has tested and guaranteed accuracy. This corresponds to a VGA gain code range of 77 to 1023. The Gain Accuracy Specifications also include a *PxGA* gain of approximately 3.3 dB, for a total gain range of 6 dB to 40 dB.

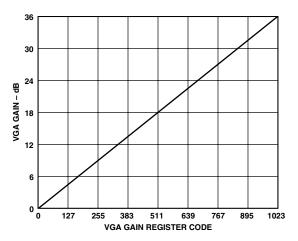


Figure 29. VGA Gain Curve (Gain from PxGA Not Included)

Optical Black Clamp

The optical black clamp loop is used to remove residual offsets in the signal chain and to track low frequency variations in the CCD's black level. During the optical black (shielded) pixel interval on each line, the ADC output is compared with a fixed black level reference selected by the user in the clamp level register. The clamp level is adjustable from 0 to 255 LSB, in 256 steps. The resulting error signal is filtered to reduce noise, and the correction value is applied to the ADC input through a D/A converter. Normally, the optical black clamp loop is turned on once per horizontal line, but this loop can be updated more slowly to suit a particular application. If external digital clamping is used during the postprocessing, the AD9845B optical black clamping may be disabled using Bit D5 in the Operation Register (see the Serial Interface Timing and Internal Register Description section). When the loop is disabled, the clamp level register may still be used to provide programmable offset adjustment.

Horizontal timing is shown in Figure 6. The CLPOB pulse should be placed during the CCD's optical black pixels. It is recommended that the CLPOB pulse duration be at least 20 pixels wide to minimize clamp noise. Shorter pulsewidths may

 be used, but clamp noise may increase and the ability to track low frequency variations in the black level will be reduced.

A/D Converter

The AD9845B uses high performance ADC architecture, optimized for high speed and low power. Differential nonlinearity (DNL) performance is typically better than 0.5 LSB, as shown in TPC 2. Instead of the 1 V full-scale range used by the earlier AD9801 and AD9803 products from Analog Devices, the AD9845B's ADC uses a 2 V input range. Better noise performance results from using a larger ADC full-scale range (see TPC 3).

AUX1 Mode

For applications that do not require CDS, the AD9845B can be configured to sample ac-coupled waveforms. Figure 30 shows the circuit configuration for using the AUX1 channel input (Pin 36). A single 0.1 μF ac-coupling capacitor is needed between the input signal driver and the AUX1IN pin. An on-chip dc bias circuit sets the average value of the input signal to approximately 0.4 V, which is referenced to the midscale code of the ADC. The VGA gain register provides a gain range of 0 dB to 36 dB in

this mode of operation (see Figure 29). The VGA gains up the signal level with respect to the 0.4 V bias level. Signal levels above the bias level will be further increased to a higher ADC code, while signal levels below the bias level will be further decreased to a lower ADC code.

AUX2 Mode

For sampling video-type waveforms, such as NTSC and PAL signals, the AUX2 channel provides black level clamping, gain adjustment, and A/D conversion. Figure 31 shows the circuit configuration for using the AUX2 channel input (Pin 34). An external 0.1 μ F blocking capacitor is used with the on-chip video clamp circuit to level shift the input signal to a desired reference level. The clamp circuit automatically senses the most negative portion of the input signal and adjusts the voltage across the input capacitor. This forces the black level of the input signal to be equal to the value programmed into the clamp level register (see the Serial Interface Timing and Internal Register Description section). The VGA provides gain adjustment from 0 dB to 18 dB. The same VGA gain register is used, but only the 9 MSBs of the gain register are used (see Table VII.)

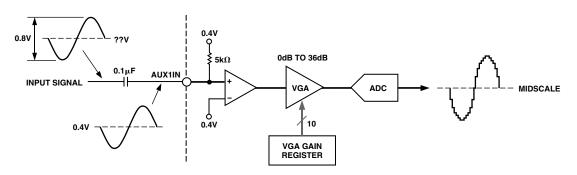


Figure 30. AUX1 Circuit Configuration

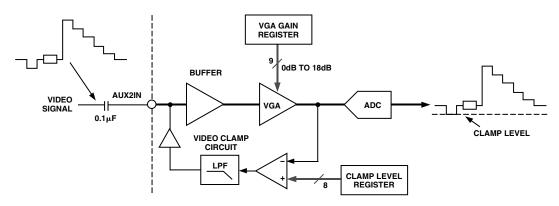


Figure 31. AUX2 Circuit Configuration

Table VII. VGA Gain Register Used for AUX2 Mode

D10	MSB D9	D 8	D 7	D6	D 5	D 4	D 3	D2	D1	LSB D0	Gain (dB)
X	0	X	X	X	X	X	X	X	X	X	0.0
	1	0	0	0	0	0	0	0	0	0	0.0
					•						•
					•						•
					•						•
	1	1	1	1	1	1	1	1	1	1	18.0

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APPLICATIONS INFORMATION

The AD9845B is a complete analog front end (AFE) product for digital still camera and camcorder applications. As shown in Figure 32, the CCD image (pixel) data is buffered and sent to the AD9845B analog input through a series input capacitor. The AD9845B performs the dc restoration, CDS, gain adjustment, black level correction, and analog-to-digital conversion.

The AD9845B's digital output data is then processed by the image processing ASIC. The internal registers of the AD9845B—used to control gain, offset level, and other functions—are programmed by the ASIC or microprocessor through a 3-wire serial digital interface. A system timing generator provides the clock signals for both the CCD and the AFE.

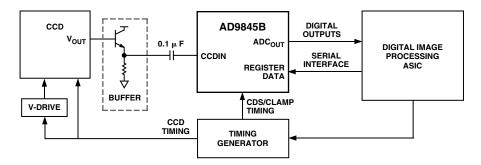


Figure 32. System Applications Diagram

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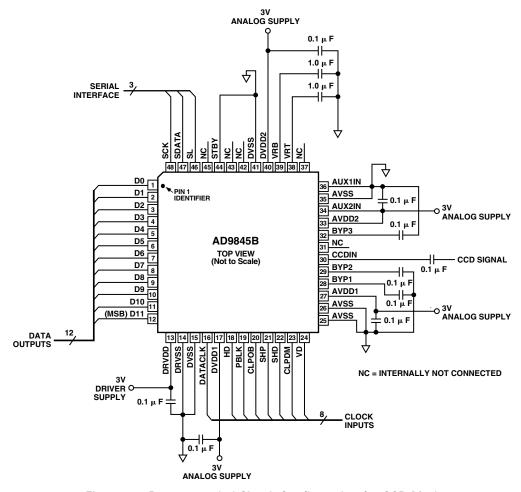


Figure 33. Recommended Circuit Configuration for CCD-Mode

Internal Power-On Reset Circuitry

After power-on, the AD9845B will automatically reset all internal registers and perform internal calibration procedures. This takes approximately 1 ms to complete. During this time, normal clock signals and serial write operations may occur. However, serial register writes will be ignored until the internal reset operation is completed.

Grounding and Decoupling Recommendations

As shown in Figure 33, a single ground plane is recommended for the AD9845B. This ground plane should be as continuous as possible, particularly around Pins 25–39. This will ensure that all analog decoupling capacitors provide the lowest possible impedance path between the power and bypass pins and their respective ground pins. All decoupling capacitors should be located as close as possible to the package pins. A single clean power supply is recommended for the AD9845B, but a separate

digital driver supply may be used for DRVDD (Pin 13). DRVDD should always be decoupled to DRVSS (Pin 14), which should be connected to the analog ground plane. Advantages of using a separate digital driver supply include using a lower voltage (2.7 V) to match levels with a 2.7 V ASIC and reducing digital power dissipation and potential noise coupling. If the digital outputs (Pins 1–12) must drive a load larger than 20 pF, buffering is recommended to reduce digital code transition noise. Alternatively, placing series resistors close to the digital output pins may also help reduce noise.

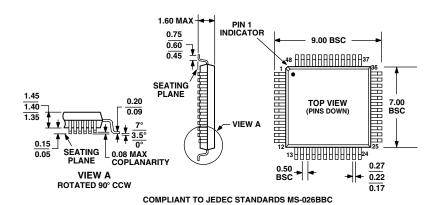
Pin 37 on the AD9845A was called CML and required a 0.1 μF bypass capacitor to ground. Pin 37 is not internally connected on the AD9845B, and so the older AD9845A bypass capacitor may be left in place. All NC pins are not internally connected on the AD9845B and may be left floating or tied to ground.

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OUTLINE DIMENSIONS

48-Lead Plasitc Quad Flatpack [LQFP] 1.4 mm Thick (ST-48)

Dimensions shown in millimeters



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